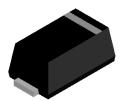
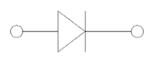
Surface Mount General Purpose Rectifier







Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Part no. with suffix "Q" means AEC-Q101 qualified

Typical Applications

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive and telecommunication.

Mechanical Date

• Package: SOD-323HE

Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free

- **Terminals**: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity: Cathode line denotes the cathode end

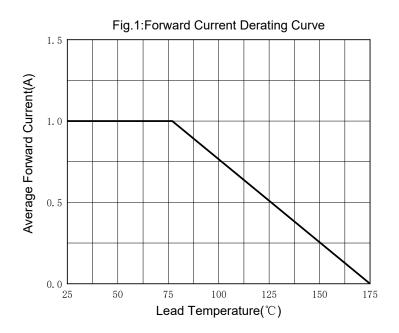
■Maximum Ratings (Ta=25°C Unless otherwise specified)

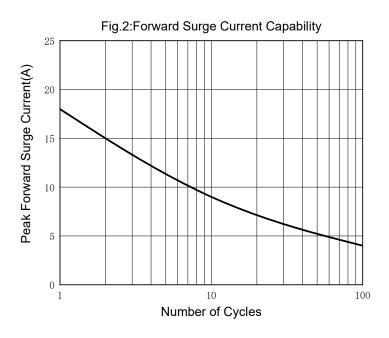
PARAMETER	SYMBOL	UNIT	FMG1AEQ	FMG1BEQ	FMG1DEQ	FMG1GEQ	FMG1JEQ
Device marking code			1A	1B	1D	1G	1J
Repetitive peak reverse voltage	V_{RRM}	V	50	100	200	400	600
Maximum RMS voltage	V_{RMS}	V	35	70	140	280	420
Maximum average forward rectified current at T _L (Fig.1)	IF _(AV)	А			1.0		
Surge(non-repetitive)forward current @ 60Hz half-sine wave,1 cycle, T _J =25°C	I _{FSM}	А			18		
Current Squared Time @1ms≤t<8.3ms Tj=25˚ℂ	l²t	A ² s			1.34		
Storage temperature	T _{STG}	°C			-55 ~+175		
Junction temperature	T_J	°			-55 ~+175		

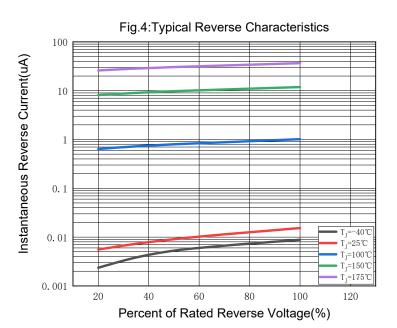
■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	FMG1AEQ	FMG1BEQ	FMG1DEQ	FMG1GEQ	FMG1JEQ		
Maximum instantaneous forward voltage drop per diode	V _F	V	I _F =1.0A			1.1				
Typical junction capacitance	CJ	pF	V _R =4V,1 MHz	5						
Maximum DC reverse current at				I 11A	T _J =25°C			5		
rated DC blocking voltage per diode	I _{RRM}	μА	T _J =125°C			50				

■ Characteristics(Typical)







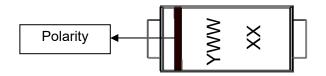
■Thermal Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	FMG1AEQ	FMG1BEQ	FMG1DEQ	FMG1GEQ	FMG1JEQ	
	$R_{\theta J\text{-}A}$		270 (1)					
Thermal resistance	$R_{\theta J\text{-}L}$	°C/W	90 (1)					
	$R_{\theta J\text{-SP}}$				10 ⁽²⁾			

Note:

- (1) Thermal resistance between junction and ambient and between junction and lead mounted on P.C.B without copper pad areas-
- (2) Thermal resistance between junction and cathode tab solder point.

■ Marking Information



Note:

- 1. All marking is at middle of the product body
- 2. All marking is in laser printing
- 3. XX is marking code, like FMG1JEQ marking code is 1J
- 4. Body color: Black
- 5. YWW is date code, "Y" is year. "WW" is week.

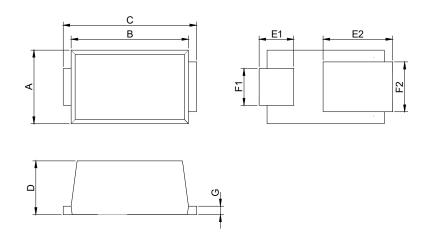
For instance:

The 17th week of 2022, date code is 217 The 17th week of 2023, date code is 317

■Ordering Information (Example)

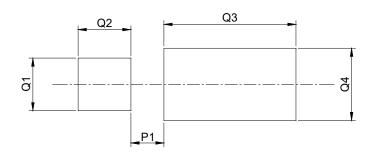
PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
FMG1AEQ~ FMG1JEQ	F1	Approximate 0.008	3000	120000	7" reel

■ Outline Dimensions



SOD-323HE					
Dim	Millimeters				
ווווט	Min	Max			
Α	1.20	1.40			
В	2.10	2.30			
С	2.30	2.70			
D	0.90	1.00			
E1	0.55	0.75			
E2	1.10	1.50			
F1	0.55	0.75			
F2	0.78	0.98			
G	0.12	0.27			

■ Suggested pad layout



SOD-323HE				
Dim	Millimeters			
P1	0.50			
Q1	0.80			
Q2	0.80			
Q3	2.00			
Q4	1.10			

3/4



Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with automotive electronics, are not designed for use in medical, lifesaving, lifesust aining, or military, Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website http://www.21yangjie.com, or consult your nearest Yangjie's sales office for further assistance.